

Silicon Carbide (SiC) **Schottky Diode** - EliteSiC, 8 A, 650 V, D1, Power88

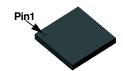
FFSM0865A

Description

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

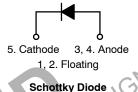
Features

- Max Junction Temperature 175°C
- Avalanche Rated 37 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery
 This Device is Pb–Free, Halogen Free/BFR Free and RoHS Compliant
 Applications
 General Purpose
 SMPS, Solar Inverter, UPS
 Power Switching Circuits





PQFN 8×8. 2P (Power88) CASE 483AP



MARKING DIAGRAM



= Assembly Plant Code

= Date Code (Year & Week)

= Lot Traceability Code FFSM0865A

= Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C unless otherwise noted)

Symbol	Parameter	Value	Unit	
V_{RRM}	Peak Repetitive Reverse Voltage	650	V	
E _{AS}	Single Pulse Avalanche Energy	37	mJ	
I _F	Continuous Rectified Forward Current @ T _C <	8	Α	
	Continuous Rectified Forward Current @ T _C <	135°C	9.6	
I _{F, Max}	Non-Repetitive Peak Forward Surge Current	T _C = 25°C, 10 μs	550	А
		T _C = 150°C, 10 μs	520	Α
I _{F,SM}	Non-Repetitive Forward Surge Current	Half-Sine Pulse, t _p = 8.3 ms	49	Α
I _{F,RM}	Repetitive Forward Surge Current	Half-Sine Pulse, t _p = 8.3 ms	25	Α
Ptot	Power Dissipation	T _C = 25°C	64	W
		T _C = 150°C	11	W
T _J , T _{STG}	Operating and Storage Temperature Range	-	-55 to +175	√ °C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter			Value	Unit
$R_{ hetaJC}$	Thermal Resistance, Junction to Case, Max		50,	2.35	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
V _F	Forward Voltage	I _F = 8 A, T _C = 25°C	10-11	1.50	1.75	V
	c G	I _F = 8 A, T _C = 125°C	0R-11	1.6	2.0	
		I _F = 8 A, T _C = 175°C	5	1.72	2.4	
I _R	Reverse Current	$V_R = 650 \text{ V}, T_C = 25^{\circ}\text{C}$	ı	-	200	μΑ
	No. Ch.	V _R = 650 V, T _C = 125°C	ı	-	400	
		$V_R = 650 \text{ V}, T_C = 175^{\circ}\text{C}$	ı	-	600	
Q_C	Total Capacitive Charge	V = 400 V	ı	27	-	nC
С	Total Capacitance	V _R = 1 V, f = 100 kHz	_	463	_	pF
	S SEP.	V _R = 200 V, f = 100 kHz	_	48	_	
< \ \		V _R = 400 V, f = 100 kHz	=	38	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Shipping [†]
FFSM0865A	FFSM0865A	PQFN 8x8, 2P (Power88) (Halogen Free)	3000 Units / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{1.} E_{AS} of 37 mJ is based on starting $T_J = 25$ °C, L = 1 mH, $I_{AS} = 8.7$ A, V = 50 V.

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TYPICAL CHARACTERISTICS

(T_J = 25°C UNLESS OTHERWISE NOTED)

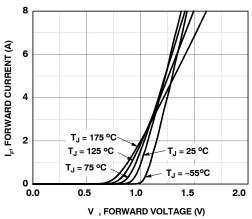


Figure 1. Forward Characteristics

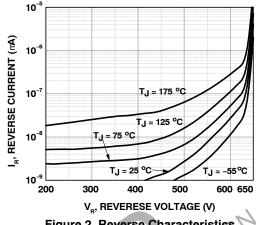


Figure 2. Reverse Characteristics

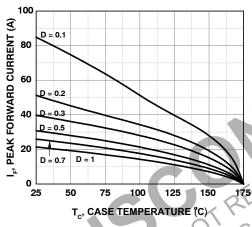


Figure 3. Current Derating

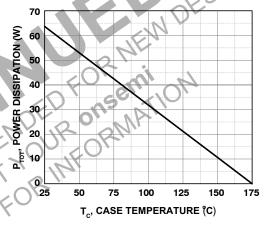


Figure 4. Power Derating

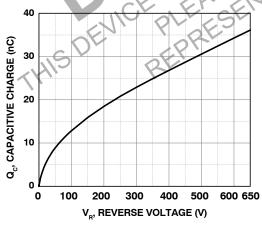


Figure 5. Capacitive Charge vs. Reverse Voltage

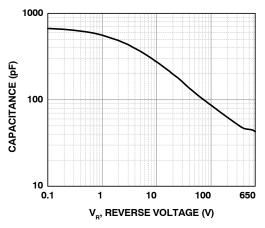


Figure 6. Capacitance vs. Reverse Voltage

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TYPICAL CHARACTERISTICS

(T_J = 25°C UNLESS OTHERWISE NOTED)

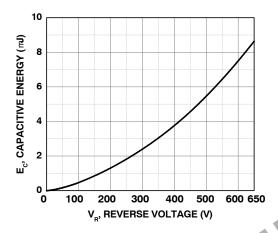


Figure 7. Capacitance Stored Energy

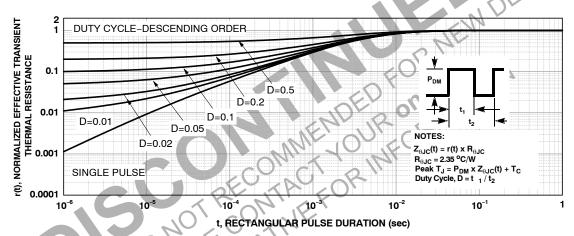


Figure 8. Junction-to-Case Transient Thermal Response Curve

TEST CIRCUIT AND WAVEFORMS

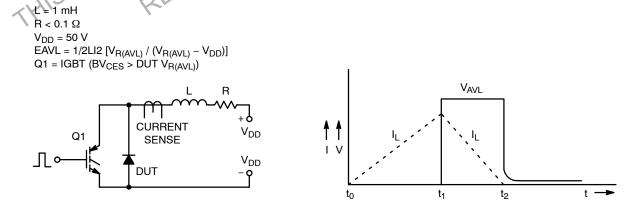
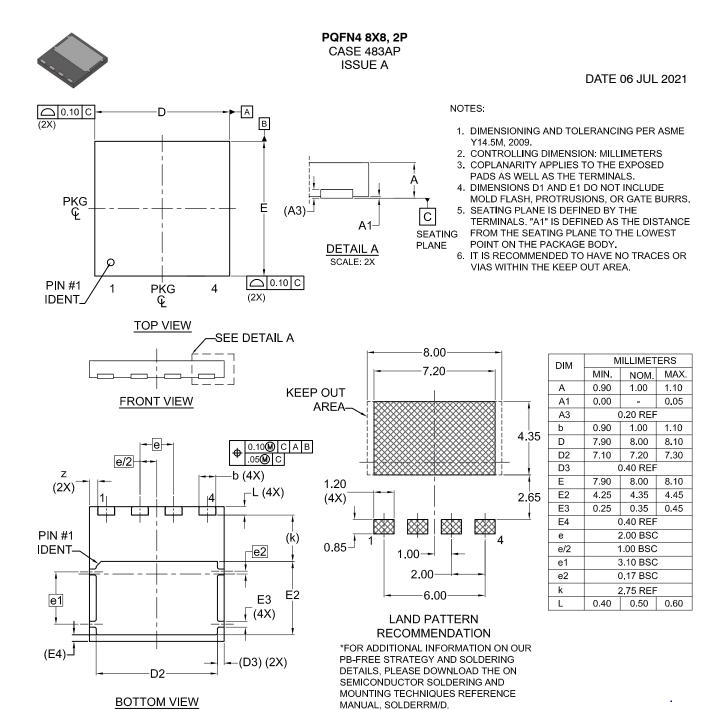


Figure 9. Unclamped Inductive Switching Test Circuit & Waveform





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DESCRIPTION:	PQFN4 8X8, 2P		PAGE 1 OF 1	

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